

Smarter technology for all

# Managing power in the AI Data Centre with Lenovo Neptune<sup>®</sup>

Jim Roche, Senior HPC Technical Architect  
Sept 2025  
[jroche@lenovo.com](mailto:jroche@lenovo.com)



# Powering the data center: the environmental impact

Until the world's power grid transitions to **low/no emission** sources, the largest contributor to IT carbon emissions is power consumption.

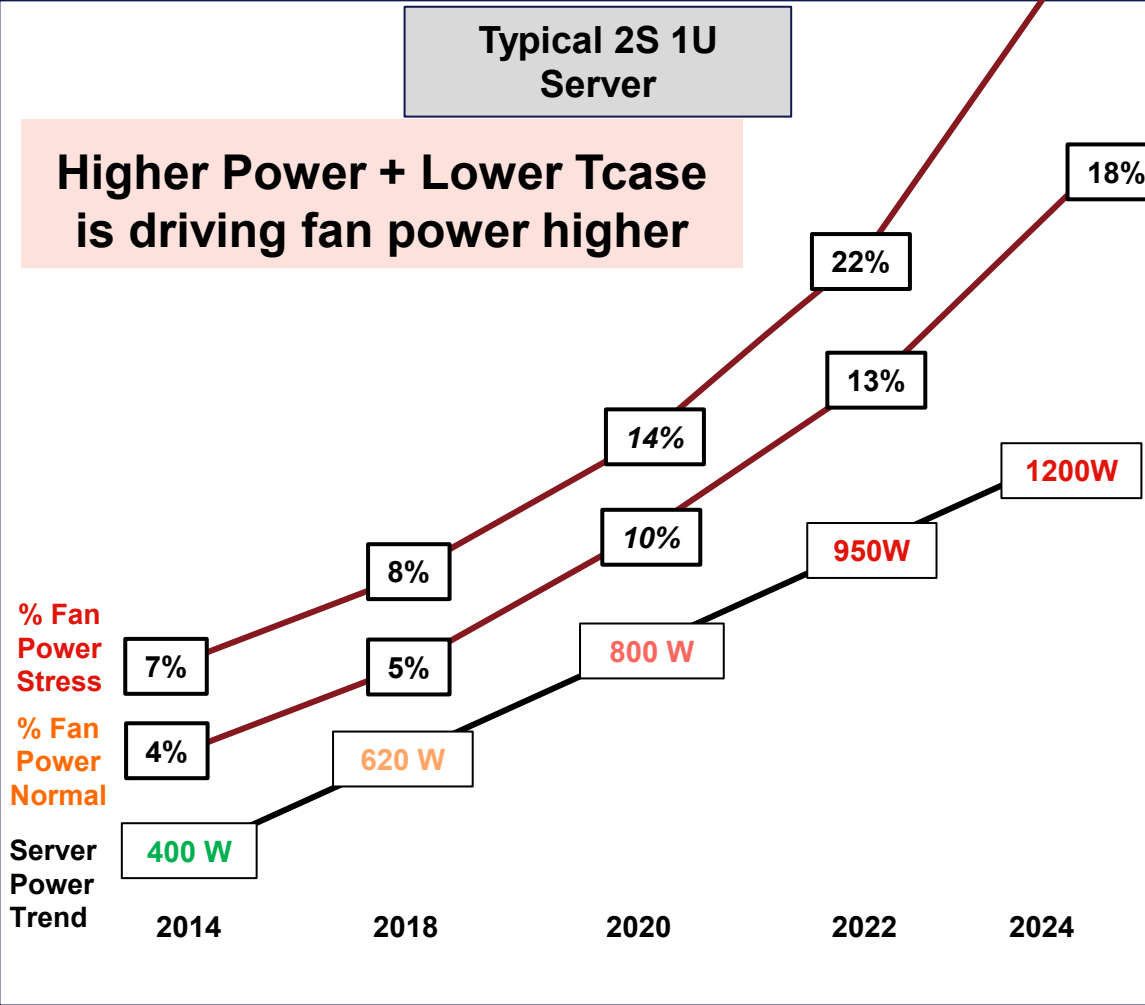
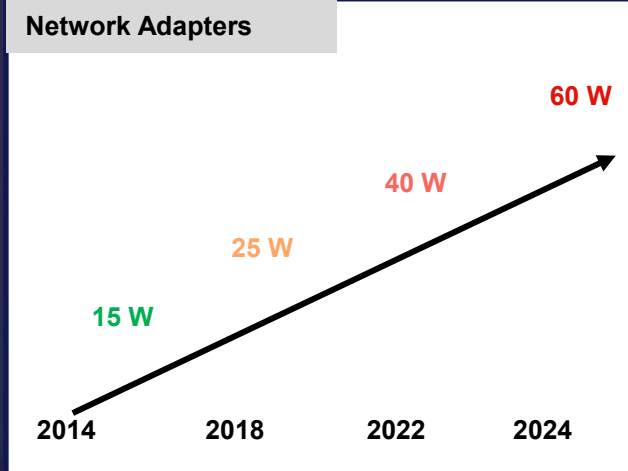
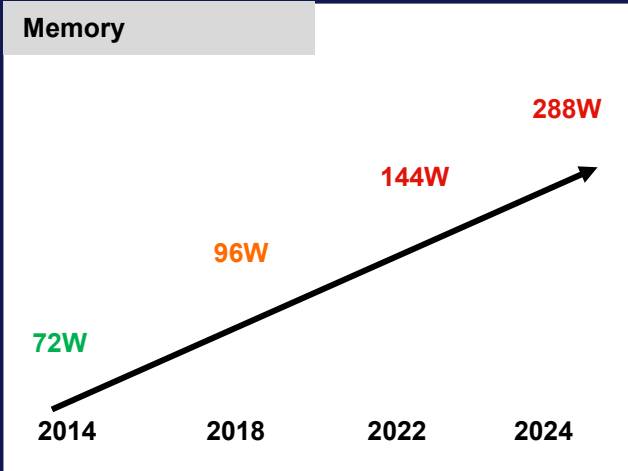
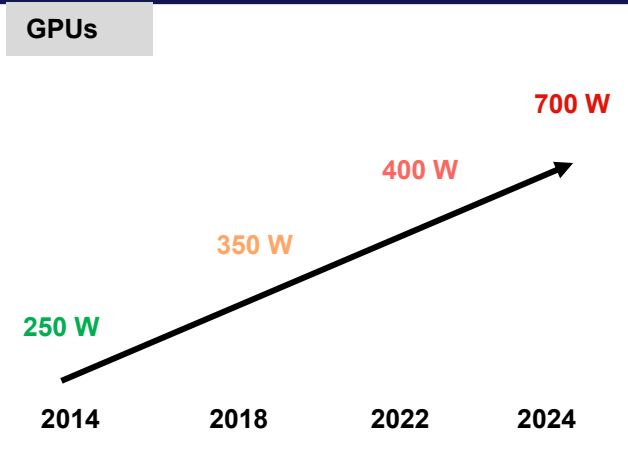
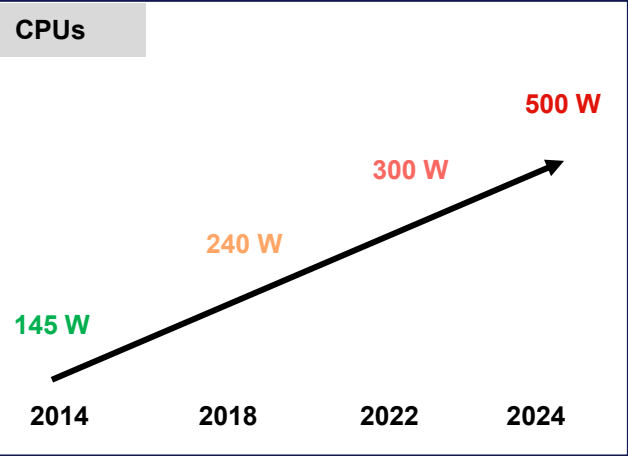
An aerial photograph of a wind turbine with three white blades, situated in a field of young, green trees planted in neat rows. The ground is dark brown, and the overall scene suggests a focus on renewable energy and environmental stewardship.

80%  
of the lifetime CO<sub>2</sub>



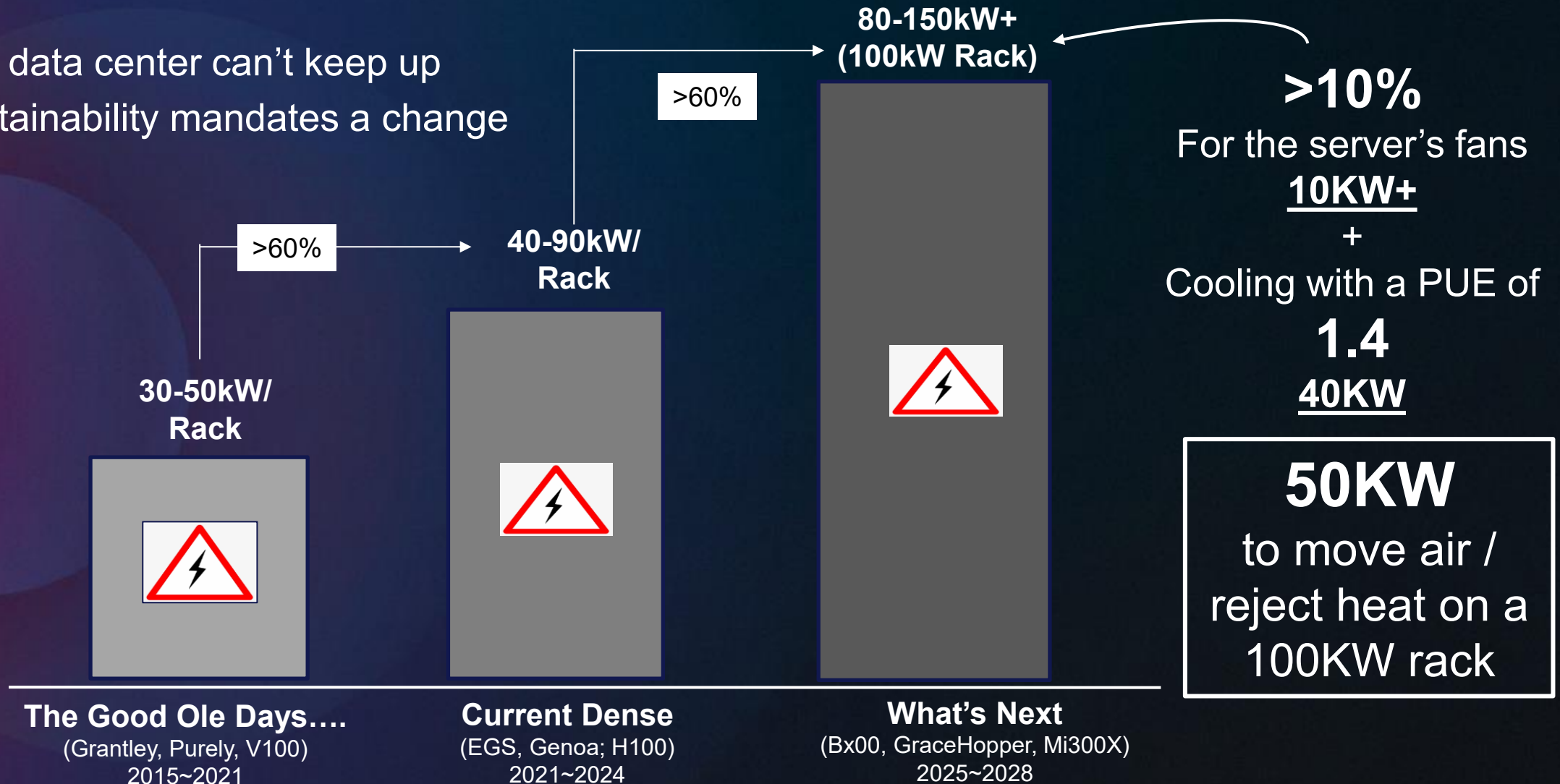
# Manufacturer's Influence

# What's is Consuming All the Power?



# AI Will Drive More Focus on The Complete Energy Picture

- The data center can't keep up
- Sustainability mandates a change



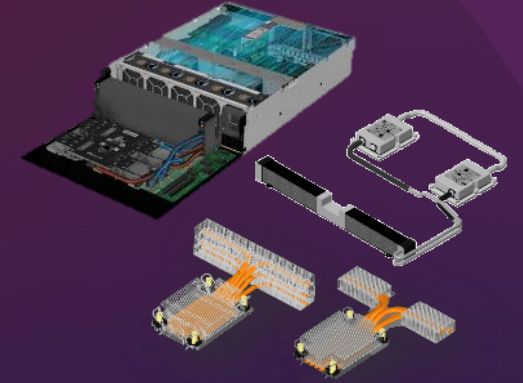
# Lenovo Neptune® Technology Family



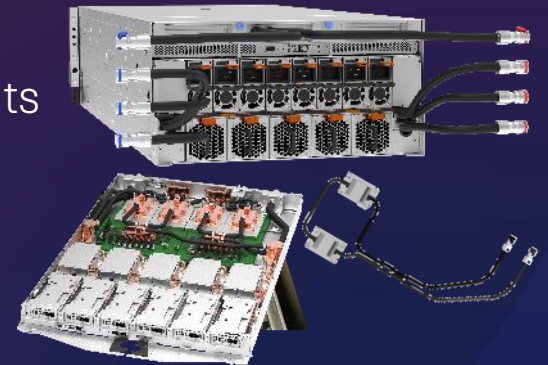
- The original, market-leading 100% direct water cooling
- Warm water up to 45°C inlet
- #1 performance density platform
- ExaScale to EveryScale™ design
- Lowest PUE



- Liquid Assisted HS Cooling to **Air**
- Closed Loop with Radiator Resign
- Best air-cooling efficiency
- Full configurability; easiest to deploy
- Highest PUE; no DC heat rejection to liquid



- Targeted at the "**hottest**" Components
- Open Loop Direct Water Cooling
- PUE ~1.2, 80% heat capture to liquid
- Maintain most configurability
- Low airflow requirement

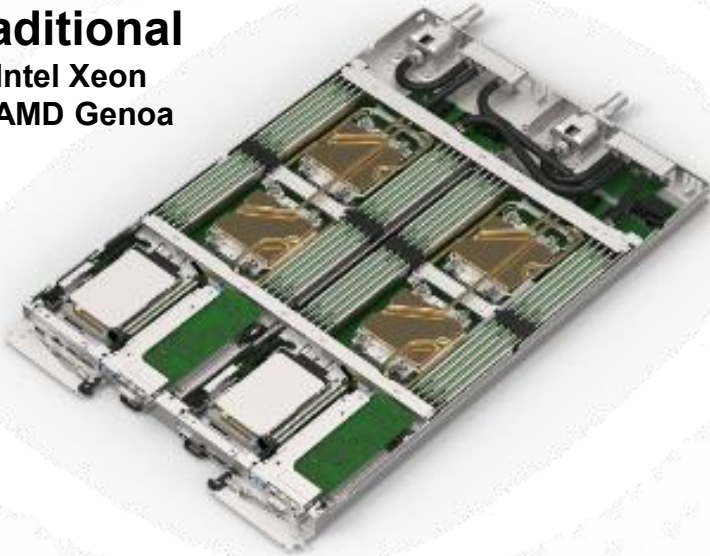


**Lenovo Neptune® offers the right choice for your datacenter at every scale.**

# Lenovo Neptune™ Direct Liquid Cooling

## Traditional

2 x Intel Xeon  
2 x AMD Genoa

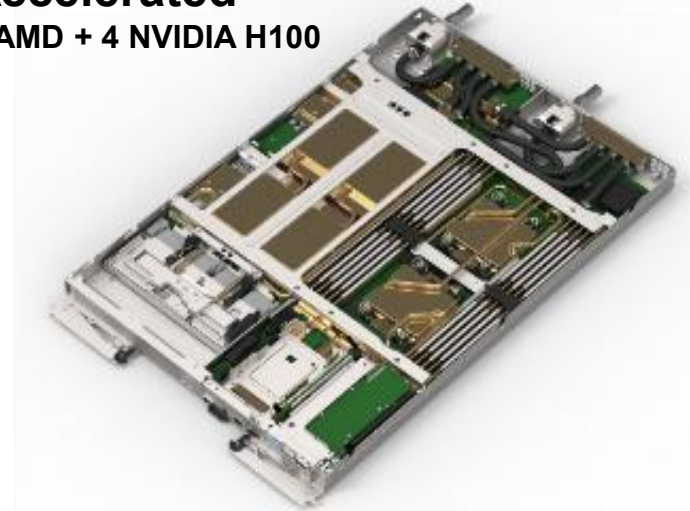


Lenovo  Neptune™



## Accelerated

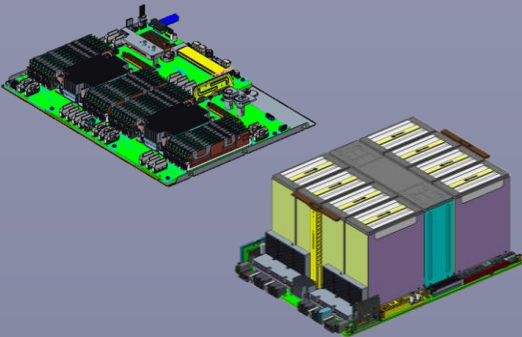
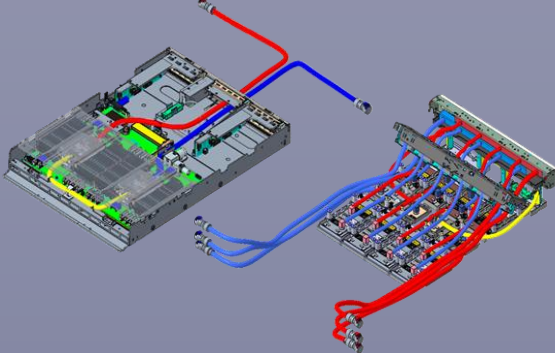
2 AMD + 4 NVIDIA H100



- Removal of fans reduces power inside the IT itself
- Liquid carries >97% of heat from the data center – reduces need for specialized AC / air handling
- Uses unchilled/warm water for cooling (>40C inlet) – chillerless operation, saves \$ and water
- Supports PUEs <1.1 providing more kW to the IT load not the overhead
- High temperature effluent allows for future recycling of heat energy
- Uses conditioned water – easy, safe, stable



# B200 Air-Cooled vs Liquid-Cooled Baseboard

Models	Air-Cooled GPU + Air-Cooled CPU	Liquid-Cooled GPU + Liquid-Cooled CPU
Cooling Modules		
Max. B200 UBB* TDP	9335 W	9335 W
Max. CPU TDP	350W	350W
Liquid Capture	—	85%
Node Power	13654W	↓ 11632W
Fan Power Saving per node	—	↓ 95% (≈1939W)
DC 42U Rack 5 node Power Saving	—	10.1KW

Note: Draft data based on Ambient 22C; Liquid inlet 45C @ 12LPM per system

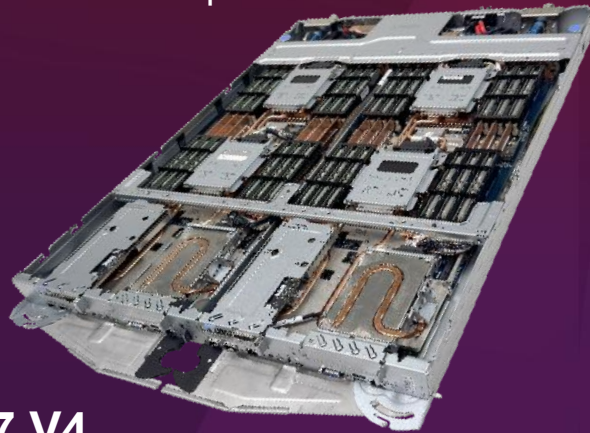


# Lenovo ThinkSystem N1380 Neptune



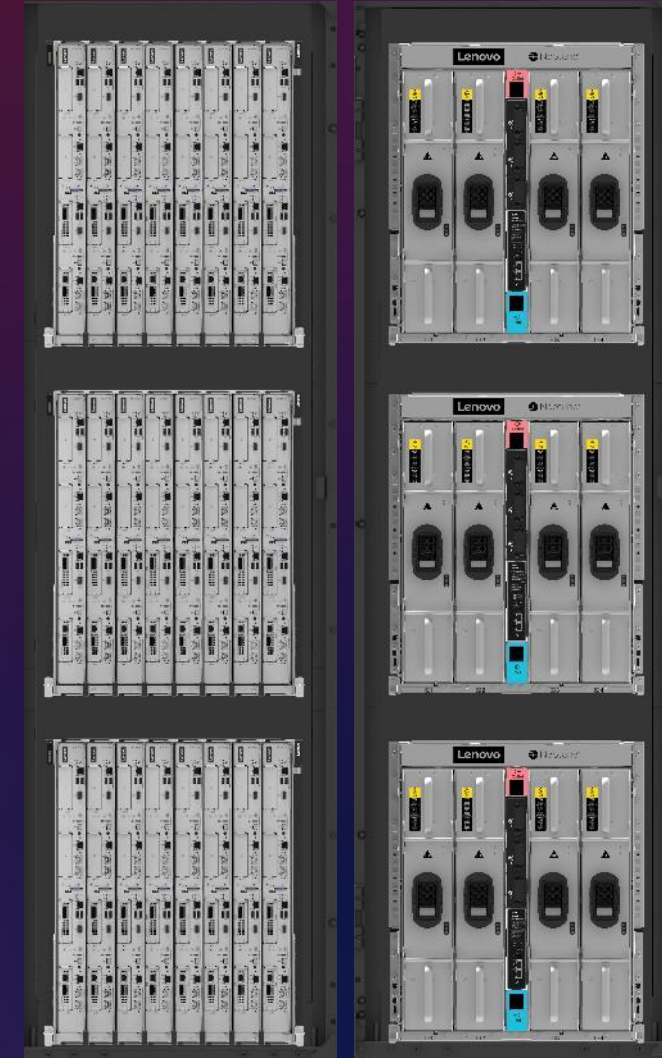
## ThinkSystem SC750 V4

2X Intel Xeon 6<sup>th</sup> Generation "Granite Rapids"





## ThinkSystem SC777 V4

2X NVIDIA GH200

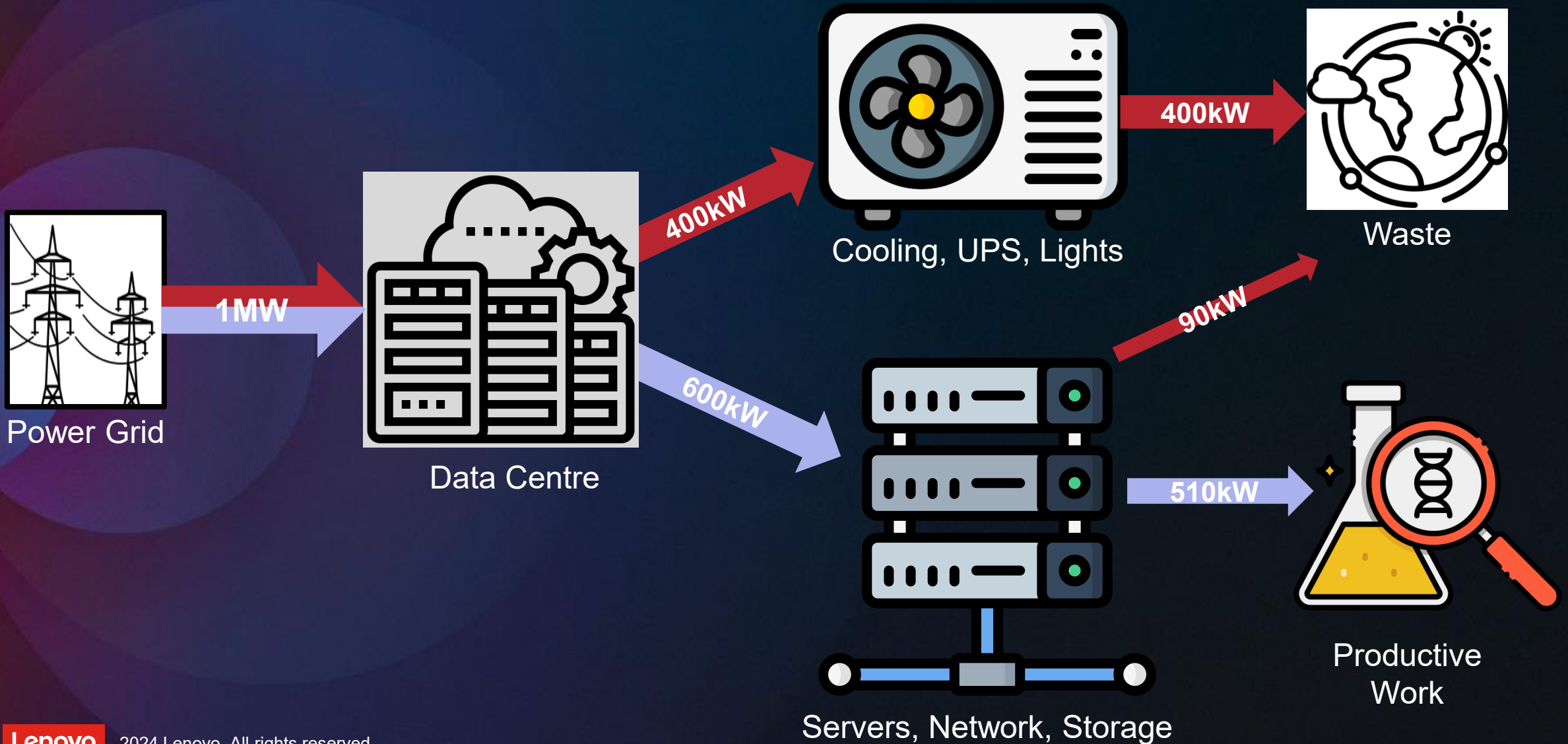


# H200 Air-Cooled vs Liquid-Cooled Server

Models	Air-Cooled GPU + Air-Cooled CPU	Fan-less DLC Server Node
Cooling Modules		
Max. H200 SXM TDP	2800 W	2800 W
Max. CPU TDP	350W	350W
Liquid Capture	—	97%
Node Power	4940W	↓ 4385W
Fan Power Saving per node	—	↓ 100% (≈555W)
DC 42U Rack 36 node Power Saving	—	20kW

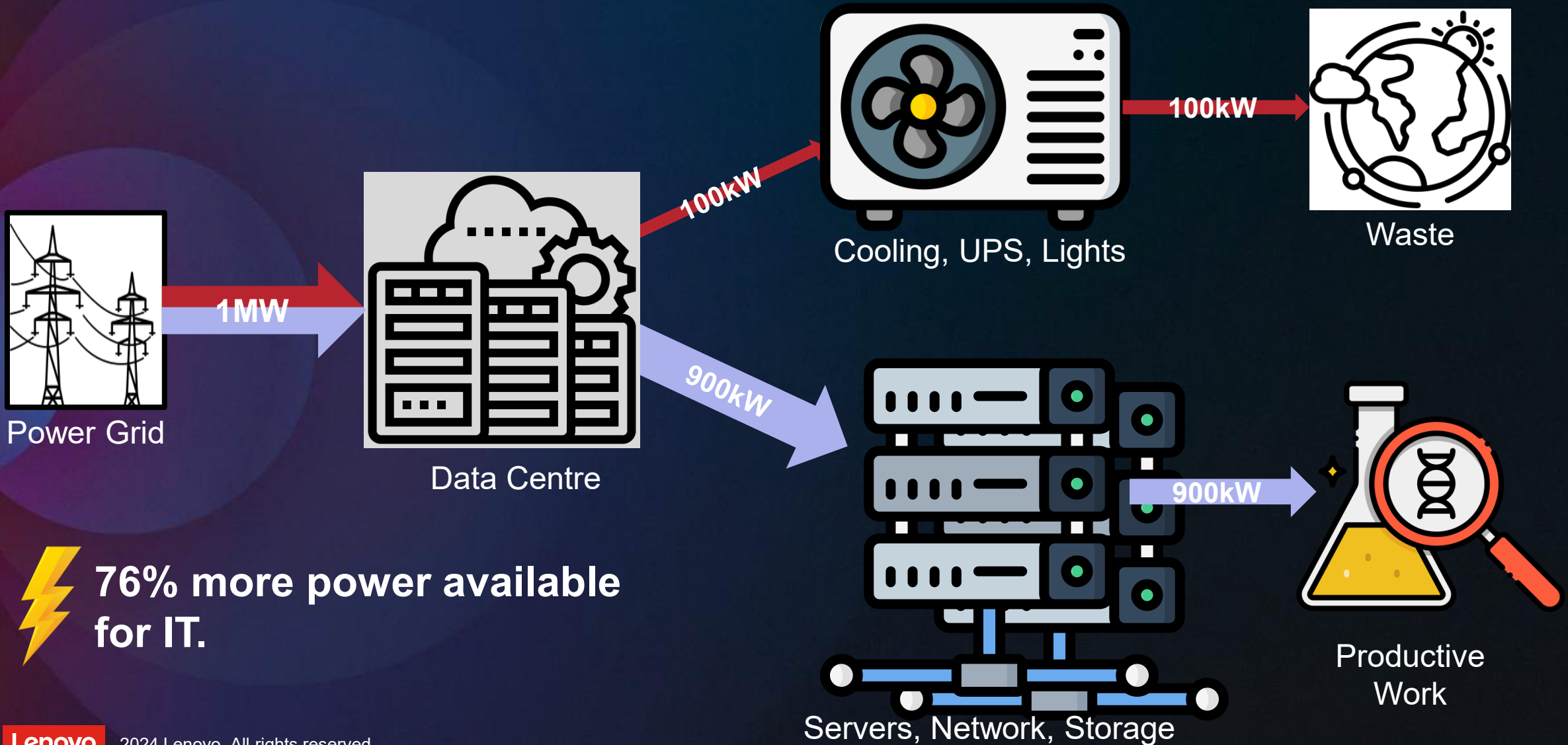
Note: Draft data based on Ambient 22C; Liquid inlet 45C @ 12LPM per system

# When Power is the Constraint...



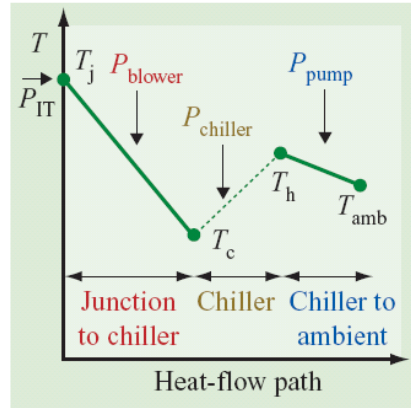


# Liquid Cooling and Power



# DC Operator's Influence

# SYSTEMS AND DATACENTER COOLING



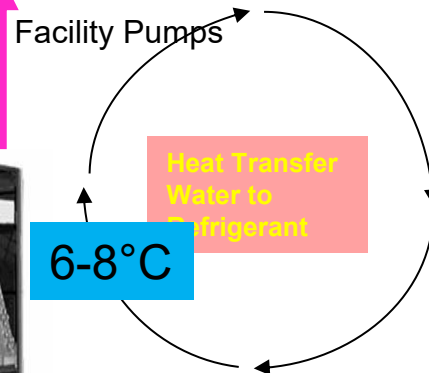
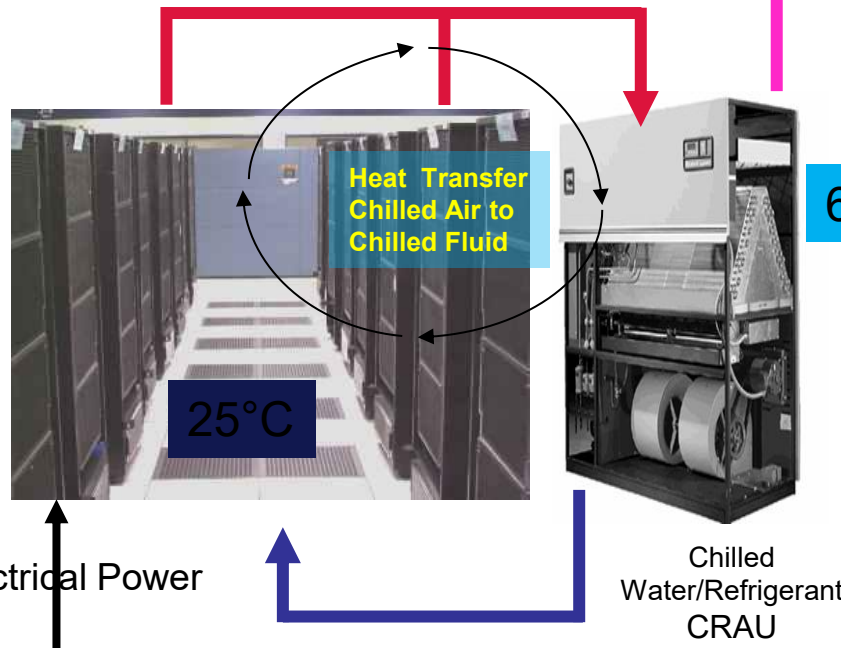
Chillers



Evaporative Tower Fans

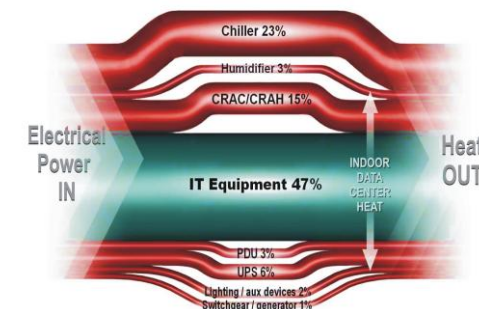
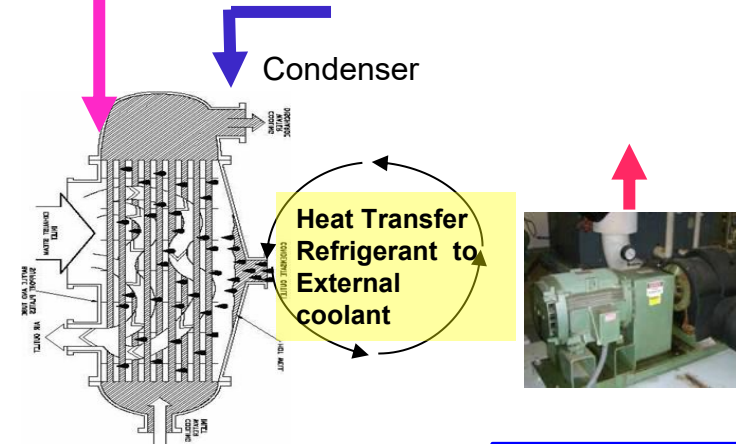


35°C



## Energy Sources:

- System Fan
- CRAU Blower
- Chiller Compressor
- Chiller Pump
- External Facility Pump
- External Tower Fans



Power Usage Effectiveness

$$PUE = \frac{\text{Total Facility Power}}{\text{IT Equipment Power}}$$

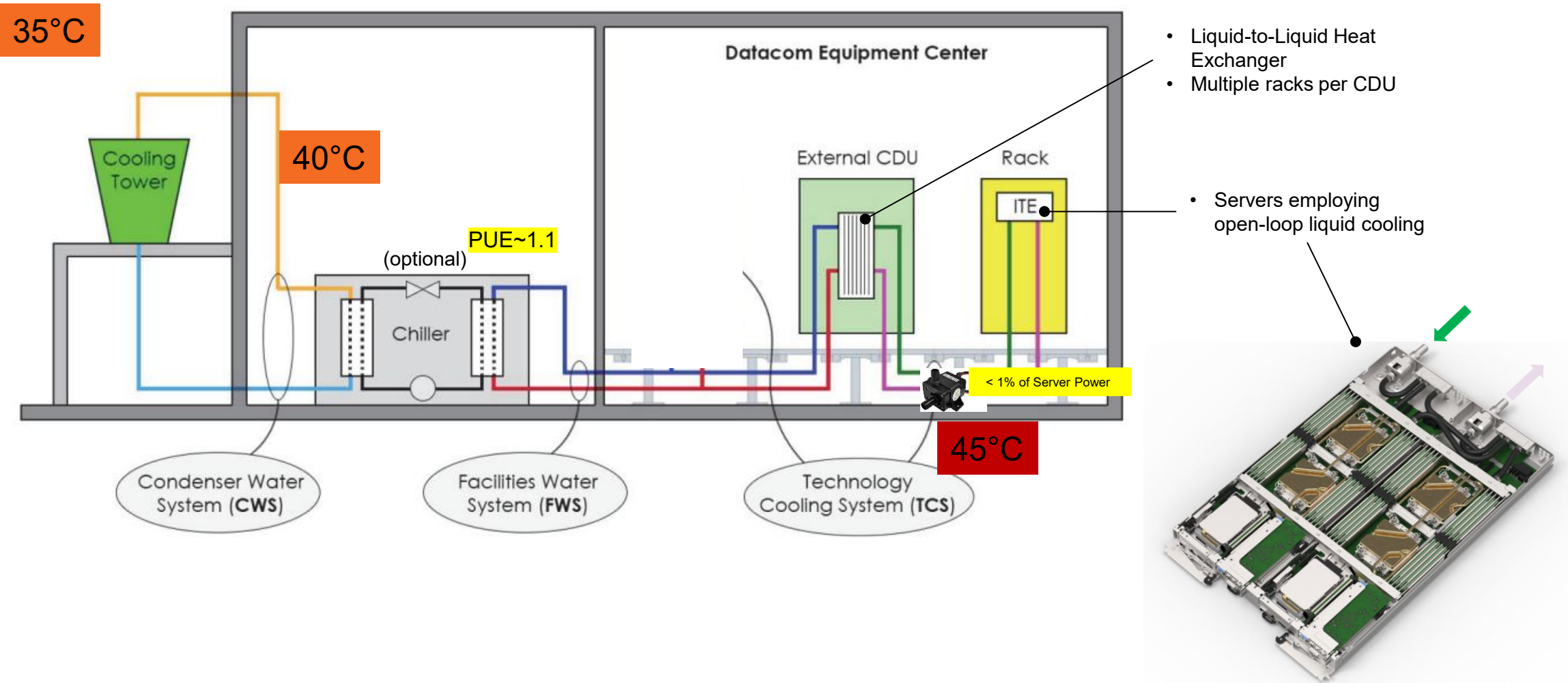
1.4 – 1.6

Electrical Power

Typical Data Center Cooling



# Direct-to-Chip Cooling in the Datacenter – Warm Water \*



## Synonyms:

- Direct Water Cooled (DWC)
- Direct-to-Chip Cooling (DTC)

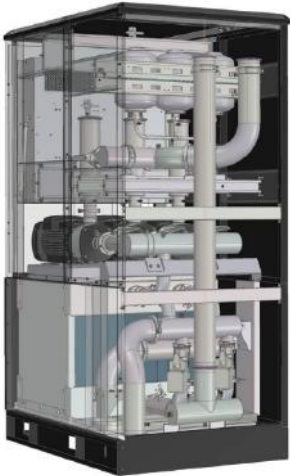
Source: ASHRAE

[https://www.ashrae.org/File%20Library/Technical%20Resources/Bookstore/WhitePaper\\_TC099-WaterCooledServers.pdf](https://www.ashrae.org/File%20Library/Technical%20Resources/Bookstore/WhitePaper_TC099-WaterCooledServers.pdf)

# Packaged CDU WCT Solution

Lenovo Services provided solution through vendor partner in region

Every solution differs due to customer resiliency requirements, existing infrastructure, location, and IT solution



FS1350  
(DN100 hygienic flange connections)

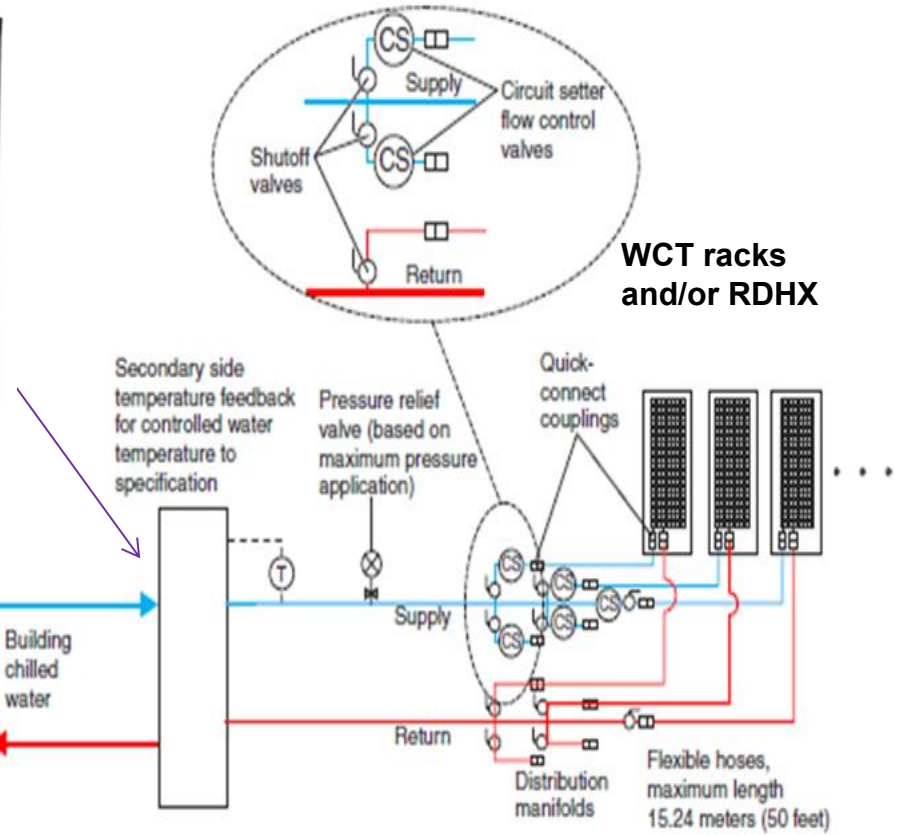
FS600  
(DN65 hygienic flange connections)

COOLTERA

RM100  
(DN40 hygienic flange connections)



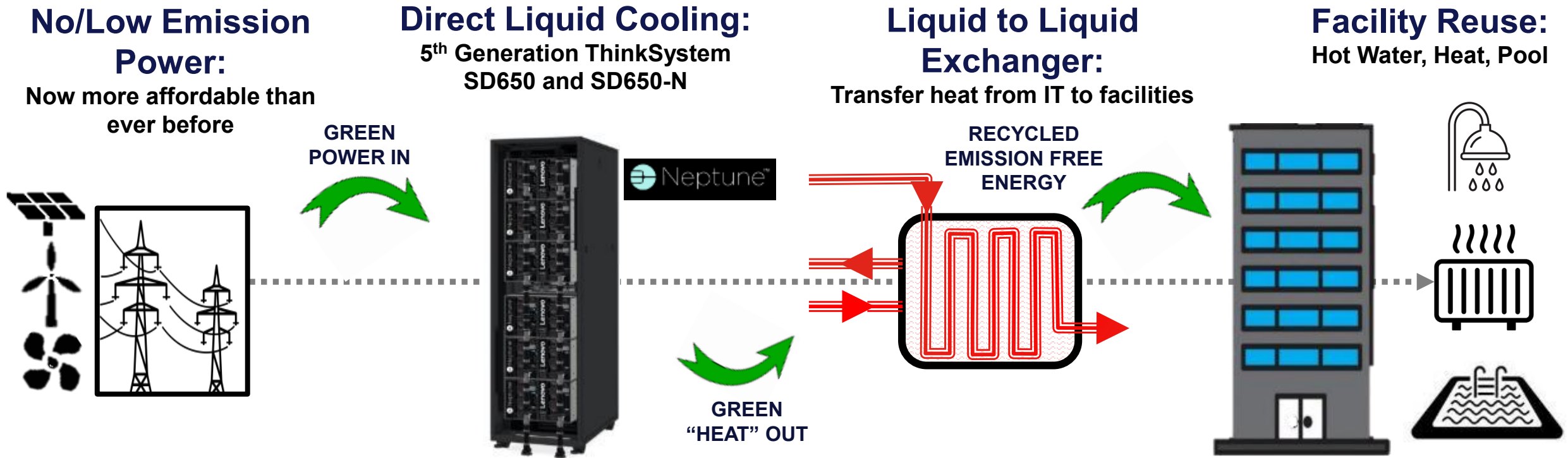
Facility Primary Water or Dry-cooler



- Supplier-built coolant distribution unit (CDU) suggested features:
- Temperature and flow metering (monitoring)
  - Leak detection or water level sensing and shutdown
  - Local and remote monitoring and control
  - Access port for filling and water treatment

# Beyond Carbon Neutral to Carbon Negative

**GOAL:** Deliver computing that is operationally carbon negative  
Requires energy efficiency + green power + energy re-use





# User's Influence



# EAR SYSTEM SOFTWARE FOR ENERGY EFFICIENT DATA CENTERS

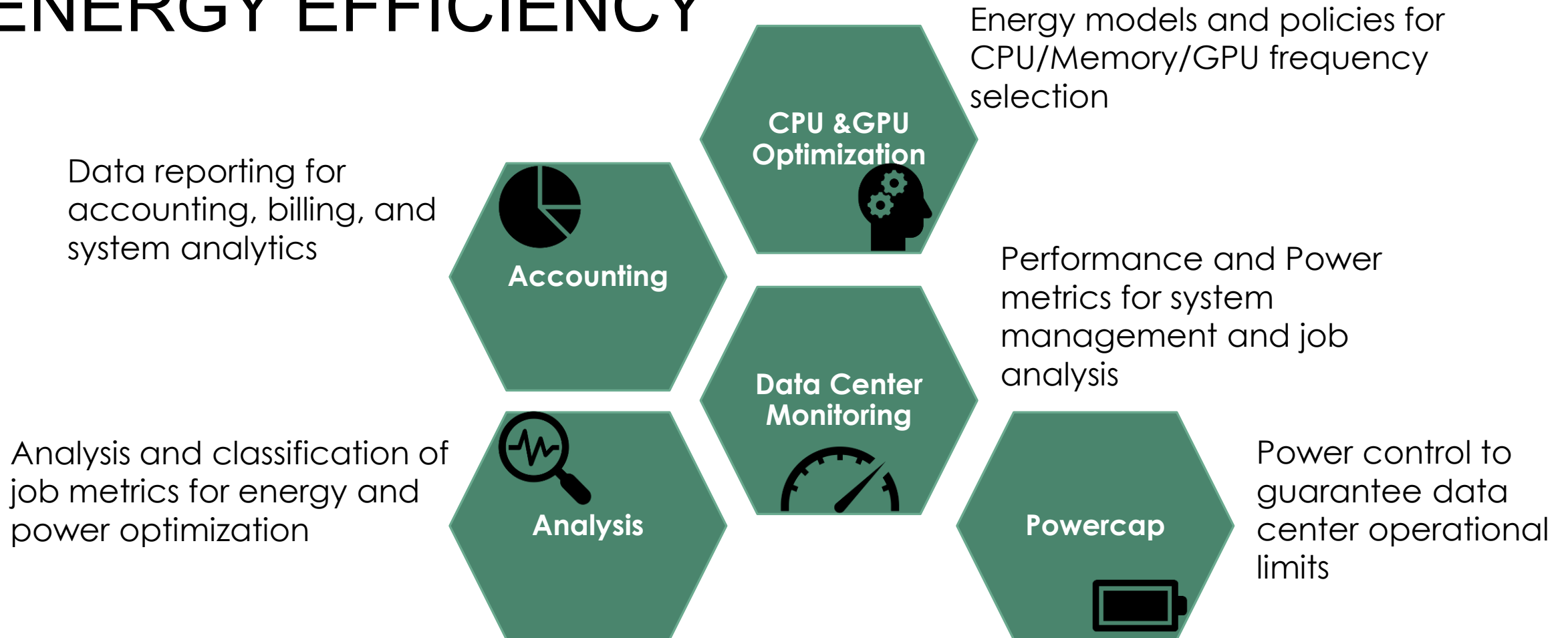
Luigi Brochard

[contact@eas4dc.com](mailto:contact@eas4dc.com)

September 2025

[www.eas4dc.com/](http://www.eas4dc.com/)

# EAR: SYSTEM SOFTWARE FOR ENERGY EFFICIENCY





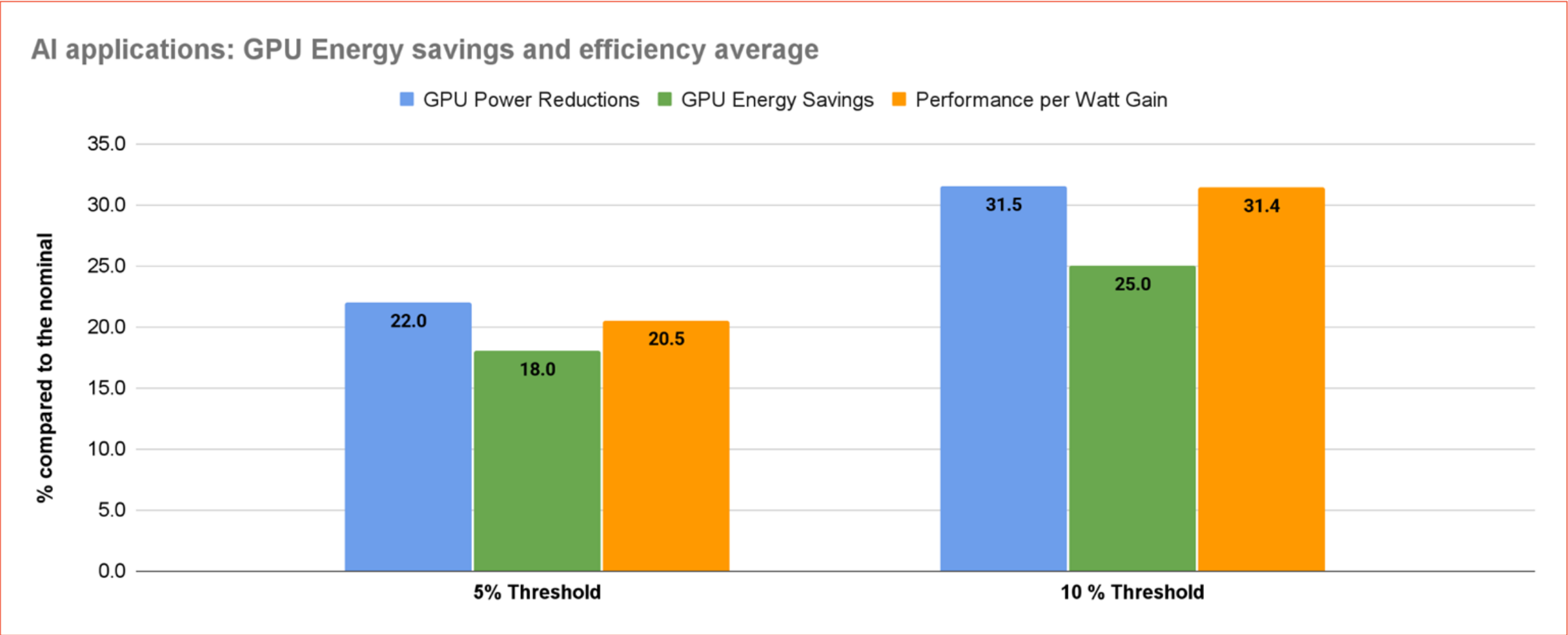
# DYNAMIC ENERGY OPTIMIZATION

- ADAPT THE POWER CONSUMPTION TO THE APPLICATION ACTIVITY



# AI APPLICATIONS

## RESULTS WITH PYTORCH AND TENSORFLOW ON NVIDIA H100

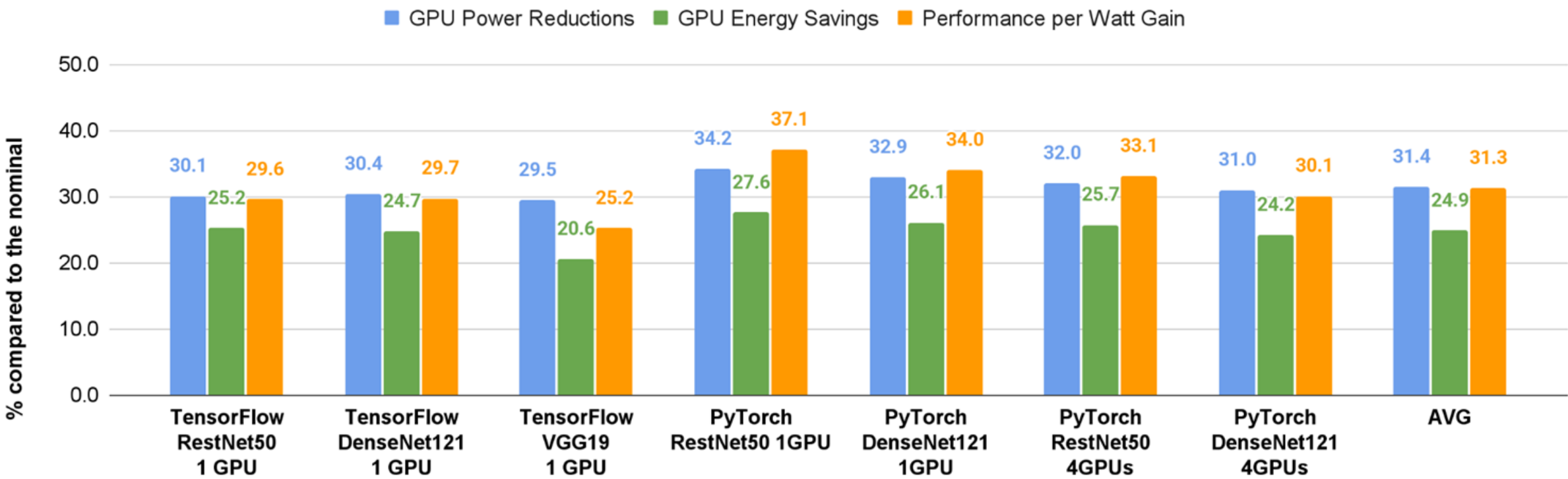


# AI APPLICATIONS

## MORE RESULTS WITH PYTORCH AND TENSORFLOW

GPU Energy savings and efficiency on H100-SXM5

10% Threshold





Smarter  
technology  
for all

Lenovo

thanks.